

FIG. 3

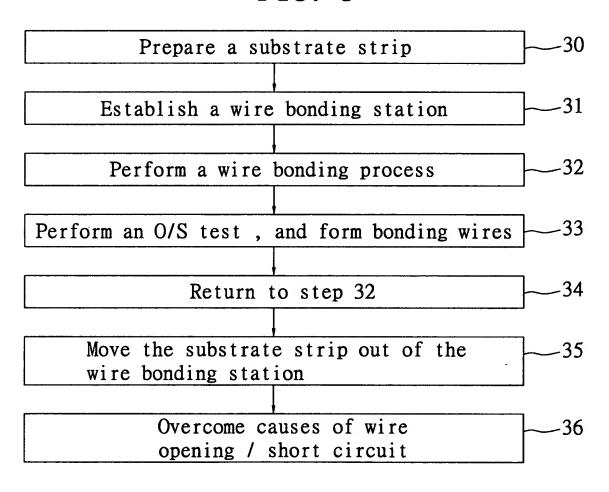


FIG. 4 Prepare a substrate strip 40 Establish a wire bonding station Perform a wire bonding process 44 -43 Perform an O/S test, and form bonding wires Determine No wire opening Wire opening / short circuit short circuit Determine> A command not to A command to interrupt interrupt the the wire bonding process wire bond process Overcome causes of wire opening / short circuit -46 Return to step 43 Return to step 43 Move the substrate strip out of Move the substrate -47 strip out of the wire the wire bonding station, and bonding station overcome causes of wire opening / short circuit

